

RA2L1/RA2E1 Group

# **Example of Low Power Application (Data Logger)**

# Introduction

This application note describes the features of RA2L1 MCU that are useful for low-power operation, typically required for logging data for long durations. The EK-RA2L1 kits are used for creating such a low-power data logging system. The functionality demonstrated here is typically required in products such as fitness trackers and fleet tracking devices. The data logger uses the 12-bit A/D converter (ADC), data transfer controller (DTC), asynchronous general-purpose timer (AGT), real-time clock (RTC), event link controller (ELC), and low-power mode (LPM). The Snooze mode and Software Standby mode are used to reduce power consumption by minimizing the CPU operation time. Application projects use the Integrated Development Environment e<sup>2</sup> studio IDE and Flexible Software Package (FSP) provided for the RA family.

This application note is described using RA2L1 MCU. However, it can also be applied to products that work with RA2E1 MCU. It includes a project that works with EK-RA2E1.

### Prerequisites

We assume that you have developed using the Renesas  $e^2$  studio IDE and Flexible Software Package (FSP). We recommend that you build and run the Blinky project according to the board's quick start guide prior to trying out this application. You can then become familiar with the  $e^2$  studio IDE and FSP and verify that the debugging connectivity to the board is working correctly.

### **Required Resources**

This application project is created for the Renesas RA Family MCU RA2L1. When applying this application note to other MCUs, be sure to change it according to the specifications of the MCU and evaluate it carefully. The resources required for this application project are as follows. This application note describes the case using the following sensor modules, but you can check the operation by inputting any analog signal without using them. See 3.4.4 Disable Sensor Dependent Process for more information.

#### Hardware

- Renesas RA Kit EK-RA2L1
- Renesas RA Kit EK-RA2E1 (optional)
- Renesas RA Kit EK-RA6M3 Serial Number 721 or later<sup>12</sup>
- Seeed Grove Base Shield V2.0 for Arduino (<u>www.seeedstudio.com/Base-Shield-V2.html</u>)
- Seeed Grove Luminance Sensor (www.seeedstudio.com/Grove-Luminance-Sensor.html)
- Seeed Grove Temperature Sensor (<u>www.seeedstudio.com/Grove-Temperature-Sensor.html</u>)

#### **Development Tools and Software**

- e<sup>2</sup> studio IDE version 2024-07 (24.7.0)
- Renesas Flexible Software Package (FSP) version 5.5.0
- GCC ARM Embedded Toolchain version 13.2.1.arm-13-7
- Segger J-Link RTT Viewer version 7.98b or later<sup>2</sup>

Note 1: Please refer to the errata document (R20ZZ0213) of the EK-RA6M3 kit for more information.

Note 2: Required for checking the operation of low-power data logger application



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# 1. Overview

# **1.1** Overview of Specifications

This application project is assumed to operate as a sub-module in the entire system, consisting of a main module responsible for consuming data generated by the sub-module. This sub-module acquires sensor data, compares against thresholds and processes the accumulated data at regular intervals. These processes are intermittently executed with Snooze mode during Software Standby mode to achieve operation as a low-power data logger. When a wakeup request is received from the main module, the processed data is transmitted.

In this application project, Snooze mode is entered every minute during Software Standby mode. While operating in Snooze mode, A/D conversion and the level judgment of the result are performed. After judging the level, the system returns to the Software Standby mode. In addition, the low-power mode is canceled every hour, and the measured data accumulated in the buffer is processed. After the data processing, the process repeats. When a wakeup request is received from the main module, the low-power mode is canceled, and the requested data is transmitted. Table 1.1 explains the details of these processes for each function.

Function	Process Description	
Data Acquisition Function	AGT count underflow event triggers A/D conversion, and conversion results are stored in the measurement data buffer.	
Level Judgement Function	The level of A/D conversion results is judged by two methods: the ADC compare function and the Data Operation Circuit (DOC). The judgment result is output to the external pin.	
Data Processing Function	The RTC alarm interrupt sets the MCU to Normal mode, and the MCU processes the accumulated data.	
Data Output Function	When a wakeup request is received, the MCU shifts to Normal mode and the data is output by UART communication.	

### Table 1.1. List of functions

Figure 1.1. shows the MCU states and mode transition events, and Figure 1.2. shows a conceptual diagram of the operation modes and current consumption.



Figure 1.1. MCU status and mode transition events





Figure 1.2. Conceptual diagram of operation mode and current consumption

### 1.1.1 Data Acquisition Function/Level Judgment Function

In the data acquisition function, the AGT timer interrupt transitions from Software Standby mode to Snooze mode and performs A/D conversion on two channels. The A/D conversion result is stored in the measurement data buffer using the DTC. The DTC transfer completion event returns the system to Software Standby mode.

The level judgment function judges the level of A/D conversion results by two methods: the ADC compare function and the Data Operation Circuit (DOC). The conversion result of channel 0 is judged by the DOC subtraction mode, and the conversion result of channel 1 is judged by the ADC compare function. If the conversion result is greater than or equal to the threshold value, the port group function of the ELC is used to output High to the external output pin.

The processing sequence for the above functions is described using Figure 1.3. .

- ① A transition to Snooze mode is requested when an AGT underflow occurs by the AGT timer set to 1 minute.
- ② The ADC starts A/D conversion by a synchronous trigger from the ELC linked event from AGT or Snooze request event and compares the result with the threshold by the compare function.
- ③ When an ADC conversion end interrupt is generated, the DTC performs transfer processing in the following order according to the transfer information set for repeat transfer mode and chain transfer.
  - a. The conversion result of A/D converter channel 0 is transferred to the channel 0 measurement data buffer.
  - b. The conversion result of A/D converter channel 1 is transferred to the channel 1 measurement data buffer.
  - c. The value of the level judgment threshold storage variable is transferred to the DOC data setting register.
  - d. The conversion result of A/D converter channel 0 is transferred to the DOC data input register.
- ④ When the level judgment result event (Data Operation Circuit interrupt) of channel 0 is output to the ELC, pin P105 of I/O port 1 is output to High. When the level judgment result event (ADC12 compare match) of channel 1 is output to the ELC, pin P208 of I/O port 2 is output to High.
- (5) When a Not DTC transfer completion interrupt (DTC\_TRANSFER) is generated due to the completion of the transfer processing of (3), the system returns to the Software Standby mode.



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Low power mode	Snooze Software standby
AGT AGT underflow	1
LPM Snooze request	
ADC A/D scan (channel 0/1) ADC compare (channel 1)	
ADC scan end event	
ADC compare match event	
A/D compare function window A lower-side level setting register	0x0300
ADC ch0 data register	0xxxxx X 0x0150
ADC ch1 data register	
DTC DTC transfer	
Not DTC transfer completion event	
DOC data setting register	0xxxxx 0x0200
DOC data input register	0x0000x 0x0150
DOC level judgement (channel 0)	
DOC interrupt	Threshold < input data
ELC ADC scan start trigger	7
Level judgement result output (ch0)	I
Level judgement result output (ch1)	
Port	
P105	
P208	
Data region	
Threshold value	0x0200
Ch0 data buffer	0x0000x X0x0150
Ch1 data buffer	<u>0x0000x</u> X 0x0250

Note: The duration of each processing and event occurrence represents a concept.

Figure 1.3. Timing chart for data acquisition and level judgment

### 1.1.2 Data Processing Function

An RTC alarm interrupt causes the data processing function to transition from Software Standby mode to Normal mode, and the CPU processes the accumulated measurement data. After the data processing is



completed, the RTC alarm for the next transition from Software Standby mode to Normal mode is set, and then the mode transitions to the low power mode.

The above functions are described in the processing sequence as follows.

- ① The RTC generates an alarm event every hour and cancels the low-power mode.
- ② After the low power mode is canceled, the data accumulated in the measurement data buffer is processed. It calculates the average, minimum, and maximum values. The processed result is stored in the processed data buffer.
- ③ Sets the next RTC alarm after data processing is completed.
- ④ Enters the low-power mode.

#### 1.1.3 Data Output Function

The data output function transitions from Software Standby mode to Normal mode by receiving a wakeup request from the main module (External IRQ interrupt) and outputs data by UART communication. After confirming that the wakeup request pin has fallen, it transits to low power mode.

The above functions are described in the processing sequence as follows.

- ① When the wakeup request pin rises, the ICU generates an interrupt and cancels the low power mode.
- ② After the low power mode is canceled, transmit data is generated, and the SCI outputs the data.
- ③ Transits to low power mode after confirming that the wakeup request pin has fallen.

### 1.2 Peripheral Modules of RA2L1 MCU

Table 1.2 lists the main peripheral modules of the RA2L1 MCU used in this application project and their typical uses. These are illustrated in the functional overview of RA2L1 MCU in Figure 1.4.

Module	Typical Uses	
Low Power Modes	The Snooze mode and the Software Standby mode are used to achieve low power consumption.	
12-bit ADC	Converts the analog continuous-time signal from the sensor to a discrete digital signal value. The compare function is used to judge the level of this conversion result.	
DTC	The analog conversion result of the A/D converter is transferred to the buffer using the DTC in repeat transfer mode. A DTC chain transfer is used to transfer the data from the ADC data register and from RAM/ROM memory to the DOC register for level judgment.	
DOC	Uses the subtraction mode to judge the level of the A/D conversion result.	
16-bit AGT	Generates a transition request to Snooze mode and starts data acquisition timing every minute.	
RTC	Measures the time since power is on. The hourly alarm interrupt is used to cancel the low power mode and generate the timing of data processing.	
SCI	Performs UART communication with the main module.	
ELC	Connects a Snooze transition request event or an AGT underflow event to the A/D converter start conversion event. In addition, the level judgment result event by the ADC compare function, and the DOC are connected to each port output.	

 Table 1.2.
 Main peripheral modules



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Figure 1.4. Outline of RA2L1 MCU function

# 2. Description of Functions Used

This section describes the functions of the LPM, ADC, DTC, ELC, and RTC modules of the RA2L1 MCU and explains how to set them to achieve the expected operation.

### 2.1 Low Power Modes

### 2.1.1 Available Low Power Modes

Table 10.2 in the RA2L1 User's Manual (R01UH0853) describes the conditions to transition to low power modes, the states of the CPUs and peripheral modules, and the conditions to cancel each mode.

The available low-power modes are as follows:

- Sleep Mode
- Software Standby Mode
- Snooze Mode

Figure 2.1. shows a schematic diagram of the low-power mode transitions.





Figure 2.1. Schematic diagram of low power mode transitions

### 2.1.1.1 Sleep Mode

Generally, CPU operation is the most significant factor for the increase in power consumption. In this mode, the CPU halts operation but retains the value of the CPU's internal registers. Peripheral functions other than the CPU are not stopped. The Sleep mode is canceled when an available reset or interrupt occurs in Sleep mode. All interrupt sources are available. When using interrupts to cancel Sleep mode, the corresponding IELSRn register must be set prior to executing WFI instruction.

### 2.1.1.2 Software Standby Mode

This mode dramatically reduces power consumption by stopping the CPU, most on-chip peripheral functions, and oscillators. However, the CPU's internal registers, SRAM data, the on-chip peripheral functions, and I/O port status are retained.

### 2.1.1.3 Snooze Mode

This mode is an extension of Software Standby mode that allows limited peripheral modules to operate with the CPU halted. This reduces current consumption by flexible operation of peripheral modules required by the application. Snooze mode can be entered from Software Standby mode by a specified interrupt request. Interrupt requests available in Snooze mode can also transition from Snooze mode to Normal mode or Software Standby mode.

### 2.1.2 Low Power Mode Transition Events

For details on the available low-power mode transitions, refer to the relevant sections in the RA2L1 User's Manual (R01UH0853) below.

- Table: Available Snooze requests to switch to Snooze mode.
- Table: Available Snooze end requests (triggers to return to Software Standby mode).
- Table: Available interrupt sources to transition to Normal mode from Snooze mode and Software Standby mode.

Table 2.1 lists the mode transition events used in this application project.



Transition request	Event
Request for transition to Snooze mode	AGT_AGTI
Snooze mode end request	DTC_TRANSFER
Request for transition to Normal mode from Snooze mode or Software Standby mode	PORT_IRQ3 PORT_IRQ4
	RTC_ALM

#### Table 2.1. Mode transition events used in this application project

# 2.2 12-bit A/D Converter

The RA2L1 MCU includes a 12-bit successive approximation A/D converter (ADC12) unit. There are three types of scan conversion operation modes and two types of conversion modes, as shown below.

- Single scan mode: Executes the scan of the specified channel once.
- Continuous scan mode: Scanning of the specified channels is repeated until ADCSR.ADST bit is set to 0 by the software.
- Group scan mode: The scan of the channel selected in Groups A and B is executed once by the synchronous trigger.
- High-speed A/D conversion mode<sup>1</sup>: Executes A/D conversion at high speed.
- Low-power A/D conversion mode<sup>1</sup>: The A/D conversion time is longer than the High-speed conversion mode, but it executes with low power consumption.

Note 1: Refer to Section 30.3.6, "Analog Input Sampling and Scan Conversion Time," and Table 41.12, "Operating and standby current" in RA2L1 User's Manual (R01UH0853) for a deep understanding of the difference between A/D conversion modes.

### 2.2.1 A/D Conversion Channel

The RA2L1 MCU 12-bit A/D converter unit (ADC12) can select up to 19 channels (AN000AN014, AN017AN020) of analog input, temperature sensor, internal reference voltage, or CTSU TSCAP voltage. This application project uses Seeed's Grove Base Shield V2.0 for Arduino to connect the sensor through the Arduino-compatible connector of the EK-RA2L1 kit. J19-1 and J19-2 of the Arduino-compatible connector are connected to analog channels 0 (AN000) and 1 (AN001) of the RA2L1 MCU. They can be read by selecting channels 0 and 1. Figure 2.2. shows the analog signal pin connections for Arduino-compatible connectors of the EK-RA2L1 kit.

The A/D conversion channel is selected by the ADANSA0 and ADANSA1 register. A/D conversion starts from the smallest channel number according to the conversion sequence for the analog input channel (ANn). The A/D conversion result is stored in the corresponding A/D data register n (ADDRn).



Figure 2.2. EK-RA2L1 kit Arduino compatible connector analog signal pin connection



### 2.2.2 Conversion Start Event

Figure 2.3. shows ADC12 Input/Output events. The ADC12 conversion start condition can be selected from three triggers: software trigger, synchronous trigger from ELC, and asynchronous trigger by external trigger ADTRG0 pin. In this application project, the synchronous trigger from the ELC is selected as the conversion start condition.

A/D conversion of a synchronous trigger from the ELC can be started by the preset event of the ELC specified by the ELSRn register, as shown below. Set ADCSR.TRGE bit to 1 and ADCSR.EXTRG bit to 0, and select the corresponding source in ADSTRGR.TRSA[5:0] and ADSTRGR.TRSB[5:0] bits.

- Select ELC\_AD00 in the ELC. ELSR8 register
- Select ELC\_AD01 in the ELC. ELSR9 register



Figure 2.3. ADC12 Input/Output events

#### 2.2.3 Data Register Automatic Clearing Function

When the A/D data register is read by the CPU or DTC, the A/D data register (ADDRn, ADRD, ADDBLDR, ADDBLDRA, ADDBLDRB, ADTSDR, ADOCDR) can be automatically cleared to 0x0000 by setting the ADCER.ACE bit to 1.

In this application project, the value of the data register (ADDR0) must be read twice in order to transfer the conversion result of A/D converter channel 0 to the two data areas. Therefore, the data register automatic clearing function is disabled (set the ACE bit in ADCER to 0).

### 2.2.4 Compare Function

The A/D converter compare function compares the reference value with the A/D conversion result. The compare function can generate the following events.

- ADC\_WCMPM: When the ADC conversion result matches the comparison condition
- ADC WCMPUM: When the ADC conversion result does not match the comparison conditions

Compare Window A can set four comparison conditions using two control register bits as shown in Table 2.2.



Window function setting (ADCMPCR.WCMPE)	Compare Window A Comparison Condition Select (ADCMPLR0.CMPLCHAn)	Comparison condition
Disabled (0)	Less than reference value (0)	ADCMPDR0 > A/D-converted
	Greater than reference value (1)	ADCMPDR0 < A/D-converted
Enabled (1)	Out of Condition Range (0)	A/D-converted value < ADCMPDR0, or ADCMPDR1 < A/D-converted
	Within the condition range (1)	ADCMPDR0 < A/D-converted value < ADCMPDR1 value

Table 2.2.	Comparative conditions of 2 ADC compare functions
------------	---

In this application project, the window function is disabled for analog signal channel 1 to judge whether the value is greater than or equal to the threshold value. In this case, the ADC registers are set as follows:

```
//--- Set the Window_A ------
//Select a channel for Window_A Comparison
R_ADCO->ADCMPANSR_b[0].CMPCHA1 = 0x1;
//Set the Window_A Lower boundary
R_ADCO->ADCMPDR0 ADCMPDR0_b. = Level judgement threshold;
//Set the Window_A comparison condition
R_ADCO->ADCMPLR_b[0].CMPLCHA1 = 0x1;
//Enable Window_A operation
R_ADCO->ADCMPCR_b.CMPAE = 0x1;
//Enable Window_A interrupt for meeting the condition, ADC140_CMPAI
R_ADCO->ADCMPCR_b.CMPAIE = 0x1;
```

# 2.3 DTC Transfer

When the data transfer controller (DTC) is activated by an interrupt request, it transfers data according to the transfer information. To operate the DTC, the data to be transferred must be stored in an SRAM area in advance. The following three transfer modes are available.

- Normal transfer mode: One data transfer is performed by one activation.
- Repeat transfer mode: One data transfer is performed by one activation. When data of repeat size is transferred, it returns to the address at the start of the transfer.
- Block transfer mode: One block is transferred at one activation.

# 2.3.1 Transfer Start Event

The DTC can be activated by an interrupt request. When the IELSRn.DTCE bit in ICU is set to 1, the DTC is activated by the corresponding interrupt. The selector output number n (n = 0 to 31) set in the IELSRn register in the ICU is defined as the interrupt vector number. For the enabled interrupt, a particular DTC interrupt source corresponding to each interrupt vector number n is selected by IELSRn.IELS[4:0] (n = 0 to 31) bits in the ICU.

Figure 2.4. shows DTC activation by an interrupt request from a peripheral module.





Figure 2.4. DTC activation by an interrupt request from a peripheral module

# 2.3.2 Chain Transfer

The DTC can perform chain transfers in which multiple data transfers are performed continuously for a single activation source. When the CHNE bit in MRB is set to 1, this chain transfer is enabled.

In this application project, the following transfer is executed by one activation factor. Figure 2.5. shows the chain transfer operation in this case.

- The conversion result of A/D converter channel 0 is stored in the channel 0 measurement data buffer.
- The conversion result of A/D converter channel 1 is stored in the channel 1 measurement data buffer.
- The value of the level judgment threshold storage variable is stored in the DOC data setting register.
- The conversion result of A/D converter channel 0 is stored in the DOC data input register.



Figure 2.5. Chain transfer operation



When chain transfer is set using the DTC driver of FSP, the transfer information can be declared as an array of transfer\_info\_t structures, and the pointer of the first transfer information can be passed to the driver. At this time, the member chain\_mode of all transfer\_info\_t structures, except for the last transfer, must be set to TRANSFER\_CHAIN\_MODE\_EACH or TRANSFER\_CHAIN\_MODE\_END and configured for chain mode. Set the chain\_mode of the last transfer to TRANSFER\_CHAIN\_MODE\_DISABLED.

Since the FSP Configurator does not allow the creation of chained Transfer Control Blocks, the R\_DTC\_Reconfigure function should be used to override the FSP-defined transfer\_info\_t data passed through the transfer\_cfg\_t data structure instance.

The chain transfer shown in Figure 2.5. is set as follows.

```
transfer info t g dtc data transfer info[4] = {
{
    .transfer settings word b = {
           .dest addr mode = TRANSFER ADDR MODE INCREMENTED,
           .repeat area = TRANSFER REPEAT AREA DESTINATION,
           .irq = TRANSFER IRQ END,
           .chain mode = TRANSFER CHAIN MODE EACH,
           .src addr mode = TRANSFER ADDR MODE FIXED,
           .size = TRANSFER SIZE 2 BYTE,
          .mode = TRANSFER MODE REPEAT,
    },
    .p dest = address of the channel 0 data buffer,
    .p src = address of ADC channel 0 data register,
    .num blocks = 0,
    .length = size of the channel 0 data buffer,
},
{
    .transfer settings word b = {
           .dest addr mode = TRANSFER ADDR MODE INCREMENTED,
           .repeat area = TRANSFER REPEAT AREA DESTINATION,
           .irq = TRANSFER IRQ END,
           .chain mode = TRANSFER CHAIN MODE EACH,
           .src addr mode = TRANSFER ADDR MODE FIXED,
           .size = TRANSFER SIZE 2 BYTE,
          .mode = TRANSFER MODE REPEAT,
    },
    .p dest = address of the channel 1 data buffer,
    .p src = address of ADC channel1 data register,
    .num blocks = 0,
    .length = size of the channel 1 data buffer,
},
{
    .transfer settings word b = {
           .dest addr mode = TRANSFER ADDR MODE FIXED,
           .repeat area = TRANSFER REPEAT AREA DESTINATION,
```



```
.irq = TRANSFER_IRQ_END,
           .chain mode = TRANSFER CHAIN MODE EACH,
           .src addr mode = TRANSFER ADDR MODE FIXED,
           .size = TRANSFER SIZE 2 BYTE,
           .mode = TRANSFER MODE REPEAT,
    },
    .p dest = address of the DOC data setting register,
    .p src = address of the level judgment threshold storage variable,
    .num blocks = 0,
    .length = 1,
},
{
    .transfer settings word b = {
           .dest addr mode = TRANSFER ADDR MODE FIXED,
           .repeat area = TRANSFER REPEAT AREA DESTINATION,
           .irq = TRANSFER IRQ END,
           .chain mode = TRANSFER CHAIN MODE DISABLED,
           .src addr mode = TRANSFER ADDR MODE FIXED,
           .size = TRANSFER SIZE 2 BYTE,
          .mode = TRANSFER MODE REPEAT,
    },
    .p dest = address of the DOC data input register,
    .p src = address of ADC channel 0 data register,
    .num blocks = 0,
    .length = 1,
}
};
```

# 2.4 DOC Subtraction Mode

The Data Operation Circuit (DOC) compares, adds, or subtracts 16-bit data. If the selected condition is met, an interrupt request is generated. In this application project, when the measured data is greater than or equal to the threshold value, the level judgment operation to generate an event is realized by the DOC subtraction mode. The procedure for determining the level using the DOC subtraction mode is shown below. Figure 2.6. shows the states of the registers at that time.

Procedure for the level judgment using DOC subtraction mode:

- ① The threshold of the level judgment is stored in the data setting register (DODSR).
- ② The conversion result of A/D converter channel 1 is stored in the data input register (DODIR).
- ③ If the subtraction is less than 0x0000, DOCR.DOPCF flag is set to 1.





Figure 2.6. Level judgment using DOC subtraction mode

# 2.5 ELC Event Connection

The ELC uses event signals/indications generated by peripheral modules as source signals. It passes them to other modules to provide direct linkage between modules without interrupting the CPU operation. As a result, Interrupt Service Routines to the CPU from the event generating module are not required.

When event linking is used, set the ELS[7:0] bits in ELSRn for the module to which the event is linked. Also, ELCR.ELCON bits are set to 1 to enable all event links. Refer to Table 16.3 in the RA2L1 User's Manual (R01UH0853) for the event number to be set in the ELSRn register.

### 2.5.1 ELC Event Connection for ADC Start Conversion

As described above, the A/D converter starts conversion with a synchronous trigger from the ELC. In this application project, the event that triggers the ADC conversion starts is changed according to the state of the low-power mode. In Snooze or Software Standby mode, connect the Snooze request event to ADC12. Otherwise, connect AGT1 underflow interrupt to ADC12. Figure 2.7. shows the event connection in the ELC module at that time.





Figure 2.7. ELC event connection for ADC start conversion

# 2.5.2 ELC Event Connection for Outputting the Level Judgment Result

In this application project, the level judgment result is output to the external pin without CPU. Connect the events to the I/O ports as shown in Table 2.3. Figure 2.8. shows the connection in the ELC module.

#### Table 2.3. ELC event connection for level judgment result output

Event	Destination Module
Data Operation Circuit interrupt (DOC_DOPCI)	ELC_PORT1:PORT1
ADC12 compare match (ADC120_WCMPM)	ELC_PORT2:PORT2





Figure 2.8. ELC event connection for level judgment result output

# 2.5.3 Port Output by ELC Event

Port 1 and port 2 are assigned to the ELC port group function by the RA2L1 MCU. When the ELC\_PORTn (n = 1, 2) signal is generated, data is output from PODR to the external pin based on EOSR and EORR register settings, as shown below. Figure 2.9. shows the port output circuit by an ELC event.

- When EOSR is set to 1, PODR register outputs 1 to the external pin when the ELC\_PORTn (n = 1, 2) signal is generated. If EOSR = 0, PODR is retained.
- When EORR is set to 1, PODR register outputs 0 to the external pin when the ELC\_PORTn (n = 1, 2) signal is generated. If EORR = 0, PODR is retained.





# 2.5.4 Configuring ELC Event Connections in the Configurator

The ELC event connection can be configured in the FSP Configurator. Some ELC event connections (Example: ADC12 scan start event) can be conveniently configured from the Properties View, which is visible upon selecting the module seen on the **Stacks** tab. The ELC Allocation setting status can be checked with Allocations by opening Event Links, as shown in Figure 2.10. To set additional links, set them from **User** 



**Events Consumed > New User Event**. As shown in the figure below, we have added settings for port-out that cannot be set on the **Stacks** tab.

🕢 New User Event >	User Events Consumed	🛃 New User Event 🛛 🔬 Remove
User Events Produced	Peripheral Function PORT 1 PORT 2	Event DOC INT (Data operation circuit interrupt) ADC0 COMPARE MATCH (Compare mat
Allocations Peripheral Function GPT (C) GPT (D) ADC12A ADC12B DAC12 PORT 1 PORT 2 CTSU <	Event No allocation LPM SNOOZE REQUE No allocation No allocation DOC INT (Data operal ADCo COMPARE MAT No allocation	

Figure 2.10. ELC connection settings in the configurator

### 2.6 **RTC Mode Selection**

The RTC has two operation modes and two count modes.

Operation modes include normal operation mode and low-power consumption clock mode. Some features are limited to low-power modes. For more information, see Table 22.1 in the RA2L1 User's Manual (R01UH0853).

RCR4.ROPSEL can be used to select the operating mode. In this application project, the normal operation mode is selected to use the RTC alarm interrupt (RCR4.ROPSEL is set to 0).

There are two counting modes: calendar count mode and binary count mode. The calendar count mode retains the 100-year calendar from 2000 to 2099 and automatically corrects the leap year date. In binary count mode, seconds are counted, and the information is saved as a serial value. In this application project, the binary count mode is selected to measure the time (elapsed seconds) since startup.

The count mode can be selected by using RCR2.CNTMD bit. When this bit is rewritten, the next processing is performed after confirming that the value has been rewritten. If the count mode is set again, the RTC software reset is executed, and the initial settings are redone. This bit is updated synchronously with the count source, but the count mode is switched after an RTC software reset.

# 2.7 Clock Output

This application project allows checking the status of the low power mode by outputting the clock externally. This is possible because some oscillators stop in Software Standby mode.

The clock sources output from CLKOUT pins and their division factors are set by the registers below. To enable outputting from the CLKOUT pin, set CKOCR.CKOEN to 1.

- CKOCR.CKODIV[2:0], or CKOCR.CKOSEL [2:0]
- OFS1.HOCOFRQ1[2:0]

# 3. Low-power Data Logger Application

This chapter describes the detailed design of the low-power data logger application using the module features described in the previous chapter.



# 3.1 Functional Specification

This application project is implemented based on the following specifications. Figure 3.1. also shows the overall algorithm for the low-power data logger.

### 3.1.1 Data Acquisition Function

- Analog signals of two sensors (Illuminance sensor: Seeed Grove-Luminance Sensor, Temperature sensor: Seeed Grove-Temperature Sensor) connected to external pins are acquired by A/D converters.
- Analog signal input values are between the low-potential reference voltage (VREFL and VSS) and the high-potential reference voltage (VREFH and VCC) set between 0V and 3.3V, respectively.
- Acquisition of data from each sensor is performed every minute regardless of the low power mode status (using Snooze request event or AGT underflow interrupt).
- The size of the measurement data buffer is 120 samples.

### 3.1.2 Data Level Judgement Function

- After acquiring the data, the analog signal pin AN000 judges the level by DOC, and the analog signal pin AN001 judges the level by the ADC compare function.
- When AN000 is equal to or greater than the threshold (600Lux), output a high level to the level judgment result (channel 0) output pin.
- When AN001 is equal to or greater than the threshold (30.00°C), output a high level to the level judgment result (channel 1) output pin.

### 3.1.3 Data Processing Function

- Processing by the hourly RTC alarm interrupt.
- The data processing calculates the average, minimum, and maximum value of the data accumulated in the measurement data buffer.
- The processed data buffer size is 50 times (hours).
- Outputs a high level to the data full pin when the processed data buffer is full.

### 3.1.4 Data Output Function

- Output all data only when the wakeup request signal is High.
- When a command is received, data is transmitted according to the command.
- UART communication format is 115,200 bps baud rate, 8-bit data length, no parity, 1 stop bit.
- When the response to the Data-Output-Request command is completed, the output of a low level to the data full pin sets a high level by the Data Processing Function. When data output for the level judgement result reception complete command is completed, output a low level to the level judgement result output pin set a high level by Data Level Judgment Function.





Figure 3.1. Overall algorithm of the low-power data logger

# 3.2 User Interface

This chapter describes the user interface for the Low-Power Data Logger application. This application is designed to connect and execute with the main module (such as EK-RA6M3). Therefore, this chapter contains connection and communication specifications for outputting the data to main module. See chapter 4.4 "Checking the operation of the low-power data logger" for more information of checking operation using main module.



### 3.2.1 Connecting the Sensor

Figure 3.2. shows the connection diagram for the sensor. In this application project, attach Seeed's Grove Base Shield V2.0 for Arduino to the Arduino-compatible connector of the EK-RA2L1 kit. Attach the sensor module to the A0 and A1 connectors of this Base Shield with the Grove cable. This connects the analog signal pins (AN000 and AN001) of RA2L1 MCU with the analog output pins of the two sensors.

- Light Sensor Module: Seeed Grove Luminance Sensor
   Equipped with illuminance sensor APDS-9002, Operating voltage: 2.4–5 V, Measurement range: 0–1000
   Lux
- Temperature Sensor Module: Seeed Grove Temperature Sensor Equipped with NTC thermistor NCP18WF104F03RC, Operating voltage: 3.3–5 V, Operating temperature range: -40°C–125°C



Figure 3.2. Sensor connection

### 3.2.2 Connecting the Main Module

Table 3.1 and Figure 3.3. show the connection pins to the main module. Connect the PMOD1 connector of the EK-RA2L1 kit using jumper wires.

Table 3.1.	Pins to be connected to the main module (EK-RA2L1 kit)
------------	--

RA2L1 pin	EK-RA2L1 Pin	Typical Uses
P101/TxD0	PMOD1-2	Serial communication (transmission)
P100/RxD0	PMOD1-3	Serial communication (reception)
P402/IRQ4	PMOD1-7	Wakeup request reception
P208	PMOD1-8	Output level judgment result (channel 1)
P105	PMOD1-9	Output level judgment result (channel 0)
P106	PMOD1-10	Output data full status of processed data buffer





Figure 3.3. Connecting to the Main Module (PMOD1)

# 3.2.3 Data Communication Specifications

This application project performs data communication with the main module according to the following procedure and format.

### 3.2.3.1 Communication Procedure

Figure 3.4. shows the sequence diagram for the main module. The sub-module cancels the low power mode when it receives a wakeup request from the main module and sends a wakeup completion notification in response. After that, when a command is received from the main module, data according to that command is transmitted. Then, when the main module outputs a low level to the wakeup request pin, the sub-module terminates data output and enters the low power mode.





Figure 3.4. Sequence diagram with the main module

# 3.2.3.2 Communication Data Format

### (1) Receive Format

Below is the packet format/protocol of data received by the EK-RA2L1.

Packet format:

(a) Command

Description	Code	Length	Function
(a) Command	ASCII Code	1 byte	'1': Request average only data
			'2': Request all data
			(average/minimum/maximum)
			'3': Level judgement result reception complete

### (2) Transmission Format

Below is the packet format/protocol of data transmitted by the EK-RA2L1.

Packet format:

(a) Start	(b) Attribute	(c) Data	(d) Data	(e) End
code	code	length code		code



Example of Low Power Application (Data Logger)

Description	Code	Length	Function
(a) Start code	'^'	1 byte	Start of the packet
(b) Attribute code	ASCII Code	1 byte	'1': Output average only data
			'2': Output all data
			'3': Output ADC current data
			'4': Send wakeup completion notification
			'5': Send command error notification
(c) Data length code	ASCII Code	4 bytes	Indicates the length of the data section.
(d) Data	ASCII Code	Number of bytes specified in (c)	See the following Data Format
(e) End code	'\$'	1 byte	End of the packet

### (2). a. Data format

The format of the data part varies depending on the attribute code, as shown below.

• Attribute code 1 (Send average-only data)

### Format of data part:

Number of data	'/'	First data	'/'	Second data	'/'	•••	'/'	Last data
Time data	','	Light data Averag e	','	Tempe rature Data Averag e				

Attribute code 2 (send all data)

Format of data part:

Number of data	'/'	First data		'/'	Seco data	nd	'/'	••	•	'/'	Las data				
Time data	,	Light Data Averag e	','	Lig Da Mir um	ita nim	,	Ligh Data Max um.	a kim	,	Ten ratu Data Ave e	re a	,	Tempe rature Data Minim um	,	Tempe rature Data Maxim um.

• Attribute code 3 (Transmit data immediately before ADC)

Format of data part:

Time data	','	ADC	','	ADC
		current data		current data
		Light		Temperatur
				е

• Attribute code 4/5 (Send start completion notification/Send command error notification)

Format of data part:

Space (0x20)



The data comprising the format of attribute codes 1 to 3 is generated as follows. Attribute codes 4 and 5 consist of fixed data (space) of 1 byte.

- The data count consists of 0 to 9 ASCII codes. The length is 2 bytes. Example: When the system transmits "10", it sends 0x31, 0x30.
- The time/light/temperature/ADC measurement data consists of 0 to 9 ASCII codes. Example: When the system transmits a time value "1234", it sends 0x31, 0x32, 0x33, 0x34.
- The time data is composed of a 10-digit decimal number representing elapsed time.
- The light data is composed of 4-digit illuminance values rounded to the nearest whole number, and the effective range is from 0 to 1000 Lux.
- The composition of temperature data is rounded off to the third decimal place, and it is a 4-digit temperature value excluding the decimal point. The valid range is 0.00°C to 99.99°C. Example: "2840" at 28.40°C.
- The delimiter between the processed data is '/', the delimiter between the time data, the illumination data, and the temperature data is ','.
- Note: When the Disable Sensor Dependent Process function is enabled, the measurement/processed data of channel 0 is stored in the illuminance data part, and the measurement/processed data of channel 1 is stored in the temperature data part in the 4-digit ASCII code.

### 3.2.4 Input/Output Pins for Debugging

Table 3.2 and Figure 3.5. show the I/O pins for debugging this application project. The debug pins can be observed and toggled as shown below to cancel the low power modes and check the status of the modes.

RA2L1 pin	EK-RA2L1 pins or connecting components	Typical Uses
P109/CLKOUT	J1-33	Clock output
P503	LED1/Blue LED	Blinks when low power mode is canceled manually.
P504	LED2/Green LED	Turn on in Normal mode
P004/IRQ3	User switch S1	Manual cancellation of low-power mode

Table 3.2. Debugging I/O pins (EK-RA2L1 kit)



Figure 3.5. Debugging I/O pins (EK-RA2L1 kit)

# 3.2.5 User Interface on EK-RA2E1 Kit

Table 3.3 and Table 3.4 show the pins for connecting to the main module and for debugging when EK-RA2E1 is used. Refer to the EK-RA2E1 User's Manual (R20UT4825) for the location of the pins.



RA2E1 pin	EK-RA2E1 Pin	Typical Uses
P101/TxD0	PMOD1-2	Serial communication (transmission)
P100/RxD0	PMOD1-3	Serial communication (reception)
P411/IRQ4	PMOD1-7	Wakeup request reception
P208	PMOD1-8	Output level judgment result (channel 1)
P105	PMOD1-9	Output level judgment result (channel 0)
P106	PMOD1-10	Output data full status of processed data buffer

#### Table 3.3. Pins to be connected to the main module (EK-RA2E1 kit)

### Table 3.4. I/O pins for debugging (EK-RA2E1 kit)

RA2E1 pin	EK-RA2E1 pin or connecting component	Typical Uses
P109/CLKOUT	J2-27	Clock output
P915	LED1/Blue LED	Blinks when low power mode is canceled manually.
P914	LED2/Green LED	Turn it on in Normal mode
P004/IRQ3	User switch S1	Manual canceling of low-power mode

### 3.3 Clock Input

The clock from the external oscillator must be input so that the RTC or AGT can perform an accurate time count. EK-RA2L1 kit implements a 20-MHz clock crystal and a 32.768-kHz clock crystal, but by default, it is not connected to the RA2L1 MCU by a solder jumper. When accurate time counting is required, connect using a solder bridge. The project attached with this application note selects a sub-clock oscillator (external 32.768-kHz clock crystal) as the clock source.

Figure 3.6. and Figure 3.7 show the positions of the solder jumpers for external oscillator connections.



Figure 3.6. Solder jumper for external oscillator connection



Figure 3.7. Solder jumper for external oscillator connection (circuit diagram)

# 3.4 Debugging

This application project implements a pin input/output function to check the low power mode status, fast cycle debug function, and disabling sensor-dependent process function.



### 3.4.1 Canceling the Low Power Mode by Pressing Down the User Switch

User switch S1 of EK-RA2L1 can be pressed to generate an IRQ3 interrupt and cancel the low power mode. Setting a breakpoint after canceling stops the program from being executed, and each register and data can be checked.

#### 3.4.2 Checking the Low Power Mode Status

The low power mode status can be checked by observing LED2 and CLKOUT pins.

When LED2 is on, the mode is Normal. In Software Standby mode, HOCO, MOCO, and MOSC clocks are stopped. Therefore, when these clocks are set as the clock output source, the CLKOUT pin retains either a High or Low state. When toggling out, the mode is changed to Normal mode or a low-power mode other than the Software Standby mode. When the debugger is connected, the clock does not stop even if Software Standby mode is entered. Disconnecting the debugger is required to check the mode status.

Table 3. lists the pin output states in each low-power mode, and Figure 3.8. and Figure 3.9. show examples of pin outputs in each low-power mode.

 Table 3.5.
 Pin output states in each low-power mode

Low Power Modes	P109/CLKOUT	P504/LED2
Normal mode	Toggle	High
Software Standby mode	High or Low	Low
Snooze mode	Toggle	Low



#### Figure 3.8. Example of pin output in Snooze mode



Figure 3.9. Example of pin output in Normal mode

### 3.4.3 Fast Cycle Debug

This sample project implements a function to speed up the execution cycle of data acquisition and data processing in order to check the operation in a short time. To enable this feature, define

DEBUG\_FAST\_CYCLE macro in app\_common.h. When this DEBUG\_FAST\_CYCLE macro is defined, the following process is enabled, and the data acquisition period is set every 1 second and the data processing period is set every 1 minute.

- Resetting the AGT timer count (AGT)
- Changing the Added Value of the RTC Alarm Setting

#### 3.4.4 Disable Sensor Dependent Process

In this application project, you can check the operation of the data logger application using any analog signal without using the specified sensor module. To enable this feature, define the

DISABLE\_SENSOR\_DEPENDENCE macro in app\_common.h. Defining this DISABLE\_SENSOR\_DEPENDENCE macro enables the following process, and you can check the operation of data processing and data output using raw ADC read value.



- Disable unit conversion for the specified sensor module.
- Change the level judgment threshold of channel 0/1 to an arbitrary value (2500 by default).
- Change communication data format.

# 3.5 Flowcharts

Figure 3.10. Overall flow shows the overall flow of the application project.



### Figure 3.10. Overall flow

Figure 3.11. shows the module initialization processing flow.













### Figure 3.12. Main loop processing

Figure 3.13. shows the flow of RTC alarm interrupt processing.





### Figure 3.13. RTC alarm interrupt processing

Figure 3.14. shows the flowchart for IRQ4 interrupt processing.



### Figure 3.14. IRQ4 interrupt processing





Figure 3.15. IRQ3 interrupt processing

Figure 3.16. shows the SCI interrupt processing flow.





Figure 3.16. SCI interrupt processing

Figure 3.17. Data processing shows the flow of data processing.





Figure 3.17. Data processing







# Figure 3.18. Data output processing

# 4. Evaluating Applications

# 4.1 Import and Building a Project

To build an application project with e<sup>2</sup> studio IDE, proceed as follows:



- 1. Launch e<sup>2</sup> studio IDE.
- 2. Select any workspace in Workspace launcher.
- 3. Close **Welcome** window.
- 4. Select File > Import.
- 5. Select Existing Projects into Workspace from the Import dialog box.
- 6. Select archive file.
- 7. Select the project you want to import and click Finish.
- 8. Clicking Generate Project Content in the Configurator window
- 9. Select **Project > Build Project**.

# 4.2 Script Settings for Low Power Mode Debugging

Change the debug settings to debug applications using low-power modes. If you use J-Link to debug low-power modes for RA devices, the default debug configuration does not allow debugging. If the application tries to enter Software Standby mode, the connection between the CPU and the IDE is disconnected, and the IDE debug session is terminated. You can continue to debug in low-power modes by specifying a debug script and configuring the low-power handling option, as shown in Figure 4.1.

This debug script is provided to develop applications. Therefore, **please note that accurate lcc values cannot be measured when measuring the current consumption lcc**. Disable OCD when measuring.

The script file is included with this application project and can be used by specifying it in the debug settings.

📑 🖻 🎭 📄 🗙 🖻 🏹 🗸	Name: APN_LowPower_DataLogger_for_AnalogSensor_SubModule	FK DADLA Debug File	]
type filter text	Main Debugger Startup Common Source	EK_KAZLT DEDUG_Flat	
C (/C++ Application C (/C++ Remote Application EASE Script C GDB Hardware Debugging	Debug hardware: J-Link ARM V Target Device: R7FA2L1Al GDB Settings Connection Settings Debug Tool Settings	3	
GDB OpenOCD Debugging	✓ J-Link		^
GDB Simulator Debugging (RH850)	Туре	USB	~
🜌 Java Applet	J-Link Serial	(Auto)	
Java Application	Settings File	\${workspace_loc:¥\${ProjName}}¥\${LaunchConfigName}.jlin	
🚭 Launch Group	Script File	\${workspace_loc:¥\${ProjName}}¥CM_low_power_debug.JLi	nkScrij
Launch Group (Deprecated) Remote Java Application	Low Power Handling	Yes	<u> </u>
	✓ Interface		
C <sup>2</sup> Renesas GDB Hardware Debugging     C <sup>2</sup> APN_LowPower_DataLogger_for_AnalogS	Туре	SWD	¥
R APN LowPower DataLogger for Analogs	Speed (kHz)	4000	~
C* APN_LowPower_DataLogger_for_Analogs	✓ JTAG Scan Chain		
c <sup>*</sup> Renesas Simulator Debugging (RX, RL78)	Multiple Devices	No	~
Refesas simulator Debugging (NX, NE76)	IRPre	0	
	DRPre	0	
	✓ Connection	No	
	Register initialization Reset on connection	No	×
	Reset before run	Yes	<u> </u>
	Reset before run	105	· · ·
< >			
Filter matched 16 of 18 items		Revert	Apply

Figure 4.1. Debugging settings for LPM application debugging

# 4.3 Evaluating the Current Consumption

The EK-RA2L1 kit provides a current-measuring resistor with a resistance of 5 m $\Omega$  and a test point (TP1 and TP3) for measuring the current of the MCU power of 3.3 V. The current consumption can be calculated by measuring the voltage drop across this resistor and using Ohm's law. See Figure 4.2. and Figure 4.3. for the location of TP1 and TP3.




Figure 4.2. MCU Current Measuring Points (Circuit Diagram)



Figure 4.3. MCU Current Measuring Points

# 4.4 Checking the operation of the low-power data logger

This chapter describes the main module program used to check the operation of this application project. The main module acquires data using UART communication when the user switch is pressed or when it receives the event signal from the sub-module. The acquired data is displayed using Segger J-Link RTT Viewer.

### 4.4.1 Overview

This application operates as a main module and acquires data using UART communication from a submodule that stores sensor data at low power consumption. Data acquisition is performed when each event occurs. The acquired data is displayed on J-Link RTT Viewer on the PC.

Figure 4.4 shows a schematic diagram of the operation check method.





Figure 4.4. Overview

## 4.4.2 Description of Operation

This application acquires data from the sub-module in response to each event of the data acquisition request. As shown in Table 4.1 and Table 4.2, the data acquisition request events are 3 types of event signal reception from the sub-module and two types of user switch presses of the main module. When each event occurs, the communication sequence shown in Figure 3.4 is executed to acquire data from the sub-module. The results of the analysis of the acquired data are displayed on J-Link RTT Viewer.

For details on the format of communication data packets, refer to 3.2.3, Data Communication Specifications. Also, if the Disable Sensor Dependent Process function is enabled in the sub-module, the application of the main module should also define the DISABLE\_SENSOR\_DEPENDENCE macro in app\_common.h to enable this function.

The processing sequence at the rising edge of the level judgment result (channel 0) pin is shown below.

- 1. When a rising event of the level judgment result (channel 0) pin is detected, output a high level to the wakeup request pin.
- 2. After receiving the wake-up completion notification from the sub-module, send the data request command according to the event.
- 3. When data is received, the data packet is analyzed, and the result is displayed in J-Link RTT Viewer.
- 4. Outputs a low level to the wakeup request pin.

Figure 4.5 shows the overall algorithm of the main module.

#### Table 4.1. Request data for sub-module-generated events

Event	Requested data
Rising edge of data full pin	All data (Average, Minimum, Maximum)
Rising edge of level judgment result (channel 0) pin	ADC current data
Rising edge of level judgment result (channel 1) pin	ADC current data

#### Table 4.2. Request data for main module-generated events

Event	Requested data
User switch S1 pressed	Average only data
User switch S2 pressed	All data (Average, Minimum, Maximum)





Figure 4.5. Overall algorithm of the main module

# 4.4.3 User Interface of Main Module

# 4.4.3.1 Connecting the Sub-module

Table 4. and Figure 4.6 show the connection pins to the sub-module. Connect the PMOD2 connector of the EK-RA6M3 kit using jumper wires.

## Table 4.3. Pins connected to sub-module

RA6M3 pin	EK-RA6M3 Pin	Typical Uses
P105/TxD8	PMOD2-2	Serial communication (transmission)
P104/RxD8	PMOD2-3	Serial communication (reception)
P708	PMOD2-7	Send Wakeup Request
P803	PMOD2-8	Input level judgment result (channel 1)
P804	PMOD2-9	Input level judgment result (channel 0)
P805	PMOD2-10	Input data full state of the processed data buffer



Figure 4.6. Connecting to sub-module (PMOD2)

#### 4.4.3.2 User Switch

In this application, data acquisition can be executed at any time by pressing the user switch.

Table 4. lists the user switch connection pins and Figure 4.7 shows the user switch locations.

#### Table 4.4. User switches

RA6M3 pin	EK-RA6M3 connecting component	Typical Uses
P009/IRQ13		Average only data acquisition event
P008/IRQ12	User switch S2	All data acquisition event





Figure 4.7. Locations of the user switch

# 4.4.3.3 On-board LEDs

In this application, the status of the pins connected to the sub-module can be checked by checking the LEDs mounted on EK-RA6M3.

Table 4.5 lists the connection pins and checks of the onboard LEDs and Figure 4.8 shows the location of the onboard LEDs.

#### Table 4.5. On-board LEDs

RA6M3 pin	EK-RA6M3	Typical Uses
	connecting component	
P403	LED1 (blue)	Check the status of the wakeup request pin
P400	LED2 (green)	Check the status of the level judgment result (channel 0/1) pin.
P100	LED3 (red)	Check the status of the data full pin



Figure 4.8. Location of the On-board LEDs

### 4.4.4 Connecting J-Link RTT Viewer

This application uses Segger J-Link RTT Viewer to output the data received from the sub-module. The J-Link RTT Viewer can be connected as follows.



- 1. Launch J-Link RTT Viewer.
- 2. Select **R7FA6M3AH** in **Specify Target Device** in the **Configuration** dialogue.
- 3. Select OK.

If the project is running and a startup message is displayed, as in Figure 4.9, the connection is successful.

🔝 J-Link RTT Viewer V7.98b	_		×
File Terminals Input Logging Help			
All Terminals Terminal 0			
/*************************************			
	Enter	С	lear

Figure 4.9. Startup message on J-Link RTT Viewer

#### 4.4.5 Checking Procedure

The procedure for checking the operation of the sub-module is shown below.

- 1. Connect the main module (EK-RA6M3 kit) and sub-module (EK-RA2L1 kit or EK-RA2E1 kit) with jumper wires, referring to Table 4. and connection pins on the sub-module side.
- 2. Power on both modules.
- 3. Connect the J10 connector of the main module and PC with the USB cable.
- 4. Connect the Main Module to the J-Link RTT Viewer.
- 5. Confirm the operation status of the sub-module.

The sub-module enters the data full state every 50 hours (every 50 minutes if fast cycle debug is enabled) and performs data acquisition (see Figure 4.10). In addition, data acquisition is executed when the values of the illuminance sensor and temperature sensor exceed the threshold value (see Figure 4.11). The acquired data can be viewed on J-Link RTT Viewer. In addition, data acquisition can be performed at any time by pressing the user switch S1 or S2 on the main module (see Figure 4.12).



J-Link RTT Viewer V7.98b File Terminals Input Logging	a Help					
All Terminals Terminal 0	,					
All terminals						
5 1 5 1 6 1 1						
Event: Data full						
Wakeup message check Attribute	: UK : 2					
Data size	: 2052 [by	tesl				
Data size check	: 0K					
Data num	: 50					
Data :   Time [sec]	Light [	Lux]	Temp [C]			
	ave min		ave min max			
480	345 209		26.14 25.85 26.34			
540	360 211		26.14 25.87 26.32			
600	213 197		25.81 25.69 25.95			
660	207 193		25.75 25.62 25.93			
720	200 186		25.67 25.50 25.79			
780						
840 900	196 178   196 177		25.79 25.60 25.95   25.83 25.69 25.95			
960	206 173		25.73 25.48 25.95			
1020	186 178		25.34 25.24 25.44			
1080	187 179		25.19 25.09 25.36			
1140	181 168		25.19 25.11 25.30			
1200	177 126	208	25.36 25.15 25.54			
1260	178 143	225	25.58 25.46 25.75			
1320	158 148		25.56 25.44 25.67			
1380	177 155		25.54 25.40 25.73			
1440	164 155		25.40 25.36 25.50			
1500						
1560						
1620 1680	182 160   180 154		25.75 25.60 25.87			
1680	180 154   201 164		25.62 25.54 25.73			
1740	195 169		25.69 25.58 25.81			$\sim$
1800	105					_
				Enter	Cl	ear

Figure 4.10. Example of data acquisition triggered by data full state



<pre>File Terminals Input Logging Help All Terminals Terminal 0 Event: Analog level Channel 0 (Light) Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 184 [sec] Light 984 [Lux] Temp 27.30 [C] Event: Analog level Channel 1 (Temp) Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 195 [sec] Light 332 [Lux] Temp 30.47 [C]</pre>	🔜 J-Link RTT Viewer V7.98b	_	
<pre>Event: Analog level Channel 0 (Light) Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 184 [sec] Light 984 [Lux] Temp 27.30 [C] Event: Analog level Channel 1 (Temp) Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 195 [sec] Light 332 [Lux] Temp 30.47 [C]</pre>	File Terminals Input Logging Help		
Event: Analog level Channel 0 (Light) Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 184 [sec] Light 984 [Lux] Temp 27.30 [C] Event: Analog level Channel 1 (Temp) Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 195 [sec] Light 332 [Lux] Temp 30.47 [C]	All Terminals Terminal 0		
Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 195 [sec] Light 332 [Lux] Temp 30.47 [C]	Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 184 [sec] Light 984 [Lux]		
	Wakeup message check : OK Attribute : 3 Data size : 20 [bytes] Data size check : OK Data : Time 195 [sec] Light 332 [Lux]		
Enter Clear			

Figure 4.11. Example of data acquisition triggered by analog level judgment result

All Te	Terminals Input Logging Help				
Even	erminals Terminal 0				
	t: button S1 Wakeup message check : OK Attribute : 1 Data size : 128 [bytes] Data size check : OK Data num : 6 Data : Time [sec]   Light [Lux]   Temp [C]     ave min max   ave min max   60   704   26.94   120   262   26.066   180   264   26.12   240   303   28.01   300   299   26.76   360   360   26.43				
	<pre>ht: button S2 Wakeup message check : OK Attribute : 2 Data size : 43 [bytes] Data size check : OK Data num : 1 Data :   Time [sec]   Light [Lux]   Temp [C]       ave min max   ave min max     420   384 364 392   26.28 26.22 26.37  </pre>				
		Enter	C	lear	

Figure 4.12. Example of data acquisition triggered by pressing the button on the main module

### 5. References

Renesas FSP User's Manual

renesas.github.io/fsp

- Renesas RA MCU datasheet Select the relevant MCUs from the <u>www.renesas.com/ra</u>
- Example Projects
- github.com/renesas/ra-fsp-examples
- Application Note: <u>Getting Started with Low Power Applications for EK-RA2L1</u>



# Website and Support

- RA Product information
- RA Product Support Forum
- RA Flexile Software Package
- Renesas Support

www.renesas.com/ra www.renesas.com/ra/forum www.renesas.com/FSP

www.renesas.com/support



# **Revision History**

		Description	
Rev.	Date	Page	Summary
1.00	Jan.27.21	-	Initial version
1.10	Aug.20.24	-	Update to FSP v5.5.0



# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

#### 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

#### 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

#### 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a systemevaluation test for the given product.

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